

客户图

NOTES:

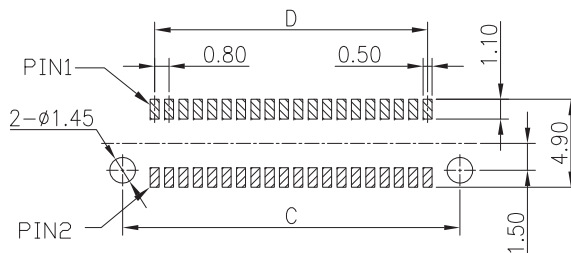
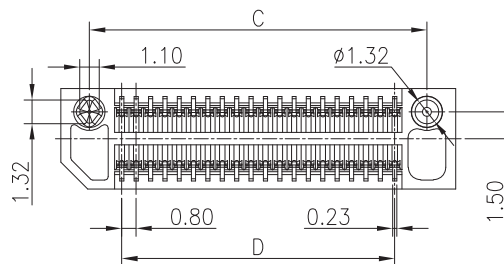
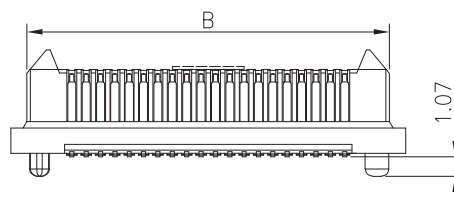
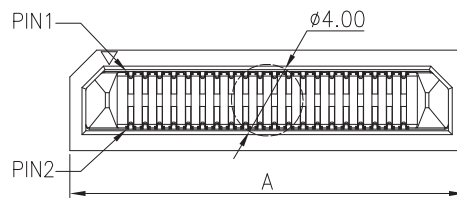
1. FINISH:
 - 1.1 HOUSING: LCP BLACK,UL94V-0.
 - 1.2 CONTACT: BeCu,GOLD (SEE P/N) PLATED IN CONTACT AREA, 80u" MIN MATTE TIN PLATED IN SOLDER AREA,50u" MIN. NICKEL UNDERPLATED OVERALL. PIN2
2. ELECTRICAL:
 - 2.1 CURRENT RATING: 2 A PER PIN(2 PINS POWERED).
 - 2.2 VOLTAGE RATING: 225V AC/318V DC.
 - 2.3 OPERATION TEMPERATURE:-55°C TO +125°C.
- 3.BURR ALLOWANCE: 0.038 Max.
- 4.MINIMUM PUSHOUT FORCE: 2.22N.
- 5.-TR PACKAGING NOT AVAILABLE ON THE 100POSITION.
-TY PACKAGING ONLY AVAILABLE ON-100 POSITION.
- 6.ORDER INFORMATION:

AA4 M XXX S2 XXX R

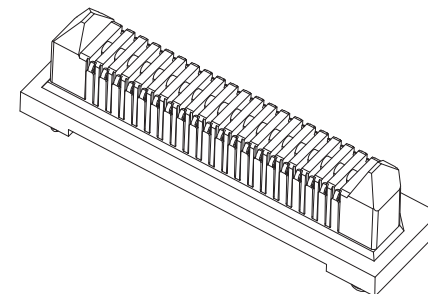
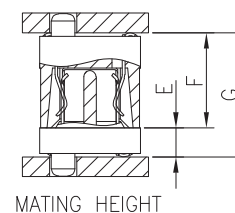
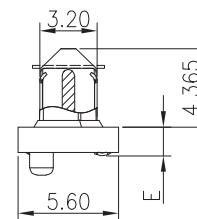
Pin数码	端子电镀:	塑胶高度:	包装方式:
010=2*5PIN	S0=Gold Flash/Tin	016=1.60mm("E")	R=载带包装
~	S1=1u" Gold/Tin	046=4.60mm("E")	
200=2*100PIN	S2=3u" Gold/Tin	076=7.60mm("E")	
	S3=5u" Gold/Tin	086=8.60mm("E")	
	S4=10u" Gold/Tin	146=14.60mm("E")	
	S6=30u" Gold/Tin		

TABLE1:

No. OF PIN	A	B	C	D
010=2x5PIN	10.00	8.20	6.80	3.20
020=2x10PIN	14.00	12.20	10.80	7.20
030=2x15PIN	18.00	16.20	14.80	11.20
040=2x20PIN	22.00	20.20	18.80	15.20
050=2x25PIN	26.00	24.20	22.80	19.20
060=2x30PIN	30.00	28.20	26.80	23.20
080=2x40PIN	38.00	36.20	34.80	31.20
100=2x50PIN	46.00	44.20	42.80	39.20
120=2x60PIN	54.00	52.20	50.80	47.20
160=2x80PIN	70.00	68.20	66.80	63.20
200=2x100PIN	86.00	84.20	82.80	79.20



RECOMMENDED PCB LAYOUT(TOP SIDE)
PCB BOARD TOLFRANCF±0.05



"E" (公头高度)	"F" (母座高度)	"G" (公母配合高)
1.60	5.40	7.00
	7.20	9.00
	9.20	11.00
4.60	5.40	10.00
	7.20	12.00
	9.20	14.00
7.60	5.40	13.00
	7.20	15.00
	9.20	17.00
8.60	5.40	14.00
	7.20	16.00
	9.20	18.00
14.60	5.40	20.00
	7.20	22.00
	9.20	24.00

GENERAL TOLERANCES UNLESS SPECIFIED		PART NO. AA4MXXXXXXXXR	CONSHARE			
X± 0.40	X°± 3°	APPROVED BY JACK	TITLE 0.80mm BTB 公头直立式 SMT			
XX± 0.25	X°± 2°		DWG NO.			
XXX± 0.15	XX°± 1°					
CUSTOMER DRAWING		CHECKED BY MIKE				
SIZE	UNITS	DRAWN BY CC				
A4	MM[INCH]					
				SHEET 1:1	SCALE 1:1	REV 4